

GLASS PASSIVATED BRIDGE RECTIFIERS

REVERSE VOLTAGE - 50 to 1000 Volts
FORWARD CURRENT - 20 Amperes

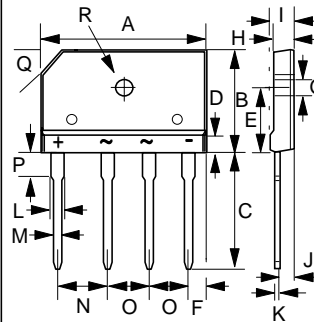
FEATURES

- Rating to 1000V PRV
- Ideal for printed circuit board
- Low forward voltage drop, high current capability.
- Reliable low cost construction utilizing molded plastic technique results in inexpensive product
- The plastic material has UL flammability classification 94V-0
- UL Recognition File # E95060

MECHANICAL DATA

- Polarity : Symbols molded on body
- Weight : 0.23 ounces, 6.6 grams
- Mounting position : Any

GBJ



GBJ		
DIM.	MIN.	MAX.
A	29.70	30.30
B	19.70	20.30
C	17.0	18.0
D	4.70	4.90
E	10.80	11.20
F	2.30	2.70
G	3.10	3.40
H	3.40	3.80
I	4.40	4.80
J	2.50	2.90
K	0.60	0.80
L	2.00	2.40
M	0.90	1.10
N	9.80	10.20
O	7.30	7.70
P	3.80	4.20
Q	(3.0) x 45°	
R	3.10 ϕ	3.40 ϕ

All Dimensions in millimeter

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.
Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%

CHARACTERISTICS	SYMBOL	GBJ 20005	GBJ 2001	GBJ 2002	GBJ 2004	GBJ 2006	GBJ 2008	GBJ 2010	UNIT	
Maximum Recurrent Peak Reverse Voltage	VRRM	50	100	200	400	600	800	1000	V	
Maximum RMS Voltage	VRMS	35	70	140	280	420	560	700	V	
Maximum DC Blocking Voltage	VDC	50	100	200	400	600	800	1000	V	
Maximum Average Forward (with heatsink Note 2) Rectified Current @Tc =100°C (without heatsink)	I(AV)					20.0				A
						3.6				
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load (JEDEC METHOD)	IFSM					240				A
Maximum forward Voltage at 10.0A DC	VF					1.05				V
Maximum DC Reverse Current @TJ =25°C at Rated DC Blocking Voltage @TJ =125°C	IR					10				uA
						500				
I ² t Rating for fusing (t < 8.3ms)	I ² t					240				A ² S
Typical Junction Capacitance per element (Note 1)	CJ					60				pF
Typical Thermal Resistance (Note 2)	R θ JC					0.8				°C/W
Operating Temperature Range	TJ					-55 to +150				°C
Storage Temperature Range	TSTG					-55 to +150				°C

NOTES : 1. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.
2. Device mounted on 300mm x 300mm x 1.6mm Cu Plate Heatsink.

